

IMAGING DEVICE

Technical Field

The present invention relates to an imaging device for apparatus such as digital cameras and digital video cameras, and more particularly to an imaging device that takes an image of an object with a single-chip image sensor.

Background Art

Conventionally, when an imaging device for taking color images is configured with a single-chip image sensor, photodiodes (pixels) are arranged like a squared grid or a 45° oblique squared grid, and color filters corresponding to color components such as R (red), G (green), and B (blue) are arranged on the photoreceptive surface of the respective photodiodes in a regular pattern such as "R G G B." For the squared grid arrangement, an output image signal for the amount of one pixel is output from each pixel of the image sensor. For the 45° oblique squared grid arrangement, an output image signal for the amount of two pixels is output from each pixel of the image sensor. Thus, an output image is generated.

In such an imaging device for taking color images, in order to generate an accurate output image, the sampling frequency of the image sensor needs to be equal to or higher

than double the spatial frequency of an object to be taken. That is, if the spatial frequency of the object is higher than the Nyquist frequency of the image sensor (half the sampling frequency), false colors (color moires) may occur at locations such as the boundary of a light portion and a dark portion of the object. Therefore, an optical low-pass filter is typically provided in the optical path with its cutoff frequency set to the Nyquist frequency of the image sensor, so that the imaging light directed to the image sensor is filtered.

As a conventional imaging device configured with a single-chip image sensor, an invention described in Japanese Patent Laid-Open No. 6-141330 has been proposed (Patent Document 1). The invention described in this specification mainly includes an image sensor of single- or two-chip type and a low-pass filter circuit having the cutoff frequency not higher than half the sampling frequency and detecting valid R, G, and B components from outputs of a video amplifier circuit.

Patent Document 1: Japanese Patent Laid-Open No. 6-141330

Disclosure of the Invention

However, with single-chip image sensors proposed so far including the invention described in the Japanese

Patent Laid-Open No. 6-141330, an output image is formed so that the pixels of the imaging sensor and the pixels of the output image are in the ratio 1:1 or 1:2. Therefore, each pixel forming the output image only receives an output signal of any one of R, G, and B from the image sensor, and signals of the other two colors are interpolated from other pixels around that pixel, so that it can be said that the output color is estimated. Thus, while a three-chip image sensor never causes false colors because each pixel receives signals of R, G, and B, a single-chip image sensor involves difficulty in reproducing exact colors and tends to cause false colors.

Further consideration of the mechanism causing the tendency of false colors poses a problem that, as shown in Figure 2 or 4, the cutoff frequency f_c of an optical low-pass filter has not been able to be set lower than half the sampling frequency (Nyquist frequency) of every color.

For example, as shown in Figures 1 and 2, for an image sensor in which color filters are arranged in a Bayer pattern on imaging pixels arranged as a squared grid (pixel pitch: d), the cutoff frequency f_c of the optical low-pass filter is preferably set lower than the Nyquist frequency for the sampling frequency of every color. In practice, to avoid sacrificing the resolution, the cutoff frequency

f_c is set to a value around $f_s/2$ (f_s : sampling frequency of the image sensor) with respect to the sampling frequency in the longitudinal and lateral directions for G, because G has a high effect on vision. While this cutoff frequency f_c can filter out unnecessary high frequencies in the longitudinal and lateral directions for G, it passes frequencies higher than the Nyquist frequency in the longitudinal and lateral directions for R and B and the Nyquist frequencies in the oblique direction for R, G, and B. Therefore, there is a disadvantage that pixel signals for these colors are not properly estimated and false colors tend to occur.

The occurrence of false colors for each color may be prevented by setting the cutoff frequency f_c of the optical low-pass filter to a value lower than the Nyquist frequency for the sampling frequency in the longitudinal and lateral directions for R and B, which is the lowest sampling frequency among those of R, G, and B. However, this has a disadvantage of the lack of signals for the G component, so that the resolution of the generated output image is reduced and the image is blurred.

As shown in Figures 3 and 4, for an image sensor in which color filters are arranged in the Bayer pattern on imaging pixels arranged as a 45° oblique squared grid (pixel pitch: d), the cutoff frequency f_c of the optical low-pass

filter is preferably set lower than the Nyquist frequency for the sampling frequency of every color. In practice, to avoid sacrificing the resolution, the cutoff frequency f_c is set to a value around $f_s/2$ (f_s : sampling frequency of the image sensor) with respect to the sampling frequency in the oblique direction for G, because G has a high effect on vision. While this cutoff frequency f_c can filter out unnecessary high frequencies in the oblique direction for G, it passes frequencies higher than the Nyquist frequencies in the other directions, i.e., the longitudinal and lateral directions, and in the longitudinal, lateral, and oblique directions for the other colors R and B. Therefore, as in the above-described squared grid arrangement, there is a disadvantage that pixel signals for these colors are not properly estimated and false colors tend to occur. Conversely, the occurrence of false colors may be prevented by setting the cutoff frequency f_c with respect to the sampling frequency of the R and B components. However, this poses a problem that the resolution of the output image is reduced and the image is blurred.

The problem of false colors as seen in the single-chip type will not occur if the image sensor is configured to be of three-chip type. However, this will pose another significant problem that the complicated mechanism will lead to the increase in size and weight, which goes against

the need for compact design. The three-chip type will also have a problem of requiring more strict positioning accuracy because misalignment in combining signals output from the imaging sensors for the respective three colors will likely to cause a disorder in the image.

The present invention has been made to solve these problems and aims to provide an imaging device capable of improving the color reproduction ability and the resolution ability to the level of a three-chip image sensor while using a simple single-chip image sensor.

An imaging device according to the present invention is including: an imaging optical system with an optical low-pass filter having predetermined frequency characteristics; color filters in a Bayer arrangement that separate an imaging light passed through the imaging optical system into predetermined color components; a single-chip image sensor that photoelectrically converts the imaging light passed through the color filters to generate pixel signals; and an output image signal generating unit that generates output image signals based on the pixel signals obtained from the image sensor, wherein the frequency characteristics of the optical low-pass filter are set in such a way that a first false color passing ratio is 0.372892484 or less but more than 0, the first false color passing ratio indicating the ratio of frequency

components allowed to pass through in a frequency component region not lower than the Nyquist frequency for the lowest sampling frequency among sampling frequencies in the longitudinal, lateral, and oblique directions for each color component in the image sensor, and lower than the Nyquist frequency for the sampling frequency of the image sensor, and the output image signals are generated from the pixel signals generated by the image sensor so that N pixel signals (N is a real number of 2 or above) generated by the image sensor correspond to one output image signal.

An imaging device according to the present invention is including: an imaging optical system with an optical low-pass filter having predetermined frequency characteristics; color filters in a Bayer arrangement that separate an imaging light passed through the imaging optical system into predetermined color components; a single-chip image sensor that photoelectrically converts the imaging light passed through the color filters to generate pixel signals; and an output image signal generating unit that generates output image signals based on the pixel signals obtained from the image sensor, wherein the frequency characteristics of the optical low-pass filter are set in such a way that a second false color passing ratio 0.194113388 or less but more than 0, the second false color passing ratio indicating the ratio of

frequency components allowed to pass through in a frequency component region not lower than the intermediate frequency between the Nyquist frequency for the lowest sampling frequency among sampling frequencies in the longitudinal, lateral, and oblique directions for each color component in the image sensor and the Nyquist frequency for the sampling frequency of the image sensor, and lower than the Nyquist frequency for the sampling frequency of the image sensor, and the output image signals are generated from the pixel signals generated by the image sensor so that N pixel signals (N is a real number of 2 or above) generated by the image sensor correspond to one output image signal.

Furthermore, in the present invention,

$$N = (f_s/F_s)^2,$$

wherein f_s is the sampling frequency of the image sensor and F_s is the sampling frequency of an output image formed by the output image signals.

According to the present invention, both the color reproduction ability and the resolution ability can be improved to the level of a three-chip image sensor while a simple single-chip image sensor is used.

Brief Description of the Drawings

Figure 1 is a schematic diagram showing a relationship between an image sensor and an output image in the case of a conventional squared grid arrangement;

Figure 2 is a schematic diagram showing a relationship between the cutoff frequency of an optical low-pass filter and the Nyquist frequency for each color in the case of the conventional squared grid arrangement;

Figure 3 is a schematic diagram showing a relationship between an image sensor and an output image in the case of a conventional 45° oblique squared grid arrangement;

Figure 4 is a schematic diagram showing a relationship between the cutoff frequency of an optical low-pass filter and the Nyquist frequency for each color in the case of the conventional 45° oblique squared grid arrangement;

Figure 5 is a schematic diagram showing an embodiment of an imaging device according to the present invention;

Figure 6 is a schematic diagram showing color filters arranged in a Bayer pattern in an image sensor of the embodiment;

Figure 7 is a schematic diagram showing pixels arranged as (a) a squared grid and (b) a 45° oblique squared grid in the image sensor of the embodiment;

Figure 8 is a diagram showing the relationship between false colors occurring in the image sensor and the spatial frequency;

Figure 9 is a diagram showing frequency characteristics of the optical low-pass filter in the case where false colors are reduced mainly by the optical low-pass filter;

Figure 10 is a diagram showing frequency characteristics of the optical low-pass filter implemented with crystal for describing a first false color passing ratio and a second false color passing ratio;

Figure 11 is a diagram showing frequency characteristics of the optical low-pass filter in the case where false colors are reduced primarily with image processing by a CPU and with less intensive filtering by the optical low-pass filter;

Figure 12 is a schematic diagram showing (a) an imaging pixel pitch, (b) a sampling interval in the longitudinal and lateral directions for G, (c) a sampling interval in the longitudinal and lateral directions for R and B, (d) a sampling interval in the oblique direction for G, and (e) a sampling interval in the oblique direction for R and B in the image sensor in which the color filters are arranged in the Bayer pattern on the imaging pixels arranged as a squared grid;

Figure 13 is a schematic diagram showing (a) an imaging pixel pitch, (b) a sampling interval in the longitudinal and lateral directions for G, (c) a sampling interval in

the longitudinal and lateral directions for R and B, (d) a sampling interval in the oblique direction for G, and (e) a sampling interval in the oblique direction for R and B in the image sensor in which the color filters are arranged in the Bayer pattern on the imaging pixels arranged as a 45° oblique squared grid;

Figure 14 is a schematic diagram showing the relationship between the image sensor and an output image in example 1;

Figure 15 is a schematic diagram showing the relationship between the image sensor and the output image in example 2;

Figure 16 is a schematic diagram showing the relationship between the image sensor and the output image in example 3;

Figure 17 is a schematic diagram showing the relationship between the image sensor and the output image in example 4;

Figure 18 is a schematic diagram showing the relationship between the image sensor and the output image in example 5; and

Figure 19 is a diagram showing the relationship between the frequency of the pixel signals generated by the image sensor and the maximum frequency $F_s/2$ that can be

represented in the output image in the examples 1 to 5 of the embodiment.

Best Mode for Carrying Out the Invention

An embodiment of an imaging device 1 according to the present invention will be described below using the drawings.

Figure 5 is a diagram showing main components of the imaging device 1 according to the present invention. The imaging device 1 according to the present invention includes: an imaging optical system 3 with an optical low-pass filter 2; color filters 4 that separate an imaging light output from the imaging optical system 3 into predetermined color components; an image sensor 5 that photoelectrically converts the imaging light passed through the color filters 4 to generate pixel signals; and an output image signal generating unit 6 that generates output image signals based on the pixel signals obtained from the image sensor 5.

Each component in this embodiment will be described in more detail. The optical low-pass filter 2 is responsible for suppressing high spatial frequency components of the imaging light. The optical low-pass filter 2 has predetermined frequency characteristics and is placed ahead of the image sensor 5 on the optical path

of the imaging light. Means with any structures capable of cutting off certain high frequencies of the imaging light, such as a crystal filter or a diffraction grating, may be used as the optical low-pass filter 2. Besides such structures capable of cutting off high frequencies of the imaging light, means capable of defocusing the imaging light directed to the image sensor 5 may be used.

In this embodiment, to reduce false colors produced by the sampling in the image sensor 5, a frequency characteristic of the optical low-pass filter 2 is set to a specified value as will be described later so that frequency components causing the false colors are suppressed.

The imaging optical system 3 is responsible for guiding the imaging light to the image sensor 5. In this embodiment, the imaging optical system 3 includes devices such as a shooting lens and an infrared cut-off filter, as well as the optical low-pass filter 2. The infrared cut-off filter is used for cutting off the infrared entering the photodiodes and is placed ahead of the optical low-pass filter 2 in the form of a glass block.

The color filters 4 are arranged regularly in a predetermined pattern on the photoreceptive surface of pixels constituting the image sensor 5 and are responsible for filtering the imaging light to make it into

predetermined color components. As tricolor filters of a first, second, and third colors implementing the color filters 4, this embodiment uses primary-color filters of R, G, and B.

The image sensor 5 is responsible for photoelectrically converting the received imaging light into electric image information and accumulating it as charge content, which is output to the output image signal generating unit 6 as electric signals. The image sensor 5 has pixels (photodiodes) arranged in a predetermined pattern, and the color filters 4 are arranged regularly in a predetermined pattern on the photoreceptive surface of the respective pixels. Generally known pixel arrangement patterns include a squared grid arrangement as shown in Figure 7(a), and a 45° oblique squared grid arrangement as shown in Figure 7(b) obtained by rotating the squared grid arrangement by 45°.

The output image signal generating unit 6 is responsible for generating output image signals by subjecting the pixel signals obtained from the pixels of the image sensor 5 to A/D conversion and various kinds of image processing. The output image signal generating unit 6 is configured with an A/D converter 7 and a CPU 8 (Central Processing Unit) and electrically connected with the image sensor 5. The A/D converter 7 converts the

pixel signals, which are analog electric signals, into digital data. The CPU 8 generates the output image signals by subjecting the A/D converted pixel signals to various kinds of image processing, such as optical black processing, white balance processing, color correction processing, color interpolation processing, noise reduction processing, edge enhancement processing, gamma correction processing, and resolution conversion processing. Here, the conversion ratio in the resolution conversion processing is set in such a way that N pixel signals (N is a real number of 2 or above) subjected to the A/D conversion correspond to one output image signal.

Although the output image signal generating unit 6 is configured with the CPU 8 in this embodiment, this is not a limitation. For example, the output image signal generating unit 6 may be configured with a DSP (Digital Signal Processor) or a hardwired logic, or the A/D converted pixel signals may be taken into a PC (Personal Computer) to cause various programs to perform the above-mentioned image processing.

Now, description will be given of the relationship between the frequency characteristics of the optical low-pass filter 2 and the conversion ratio in the resolution conversion processing of the CPU 8. As described above, to reduce as much false colors produced by the sampling

in the image sensor 5 as possible, this embodiment cuts off frequency components lower than the Nyquist frequency for the sampling frequency f_s of the image sensor 5 (hereafter referred to as the image sensor Nyquist frequency $f_s/2$), which have been allowed to pass through in conventional imaging devices.

Specifically, as shown in Figure 8, frequency components not lower than the Nyquist frequency for the lowest sampling frequency among the sampling frequencies in the longitudinal, lateral, and oblique directions for each color component in the image sensor 5 (hereafter referred to as the lowest Nyquist frequency f_a) can cause false colors. Therefore, the frequency components not lower than the lowest Nyquist frequency f_a are suppressed by the frequency characteristics of the optical low-pass filter 2 and the image processing of the CPU 8.

However, suppressing frequency components lower than the Nyquist frequency for the sampling frequency f_s of the image sensor 5 reduces the resolution of the pixel signals generated by the image sensor 5. To prevent this reduction in the resolution, this embodiment sets the conversion ratio in the resolution conversion processing of the CPU 8 in such a way that N pixel signals (N is a real number of 2 or above) generated by the image sensor 5 correspond to one output image signal. Thus, the number

of samplings in the image sensor 5 correspond to one pixel of the output image becomes two or above, and the resolution of the output image is increased up to the maximum frequency that can be represented by the output image signals (the Nyquist frequency $F_s/2$ for the sampling frequency F_s of the output image).

Now, the frequency characteristics of the optical low-pass filter 2 will be described. As described above, the imaging device 1 in this embodiment is characterized by cutting off frequency components not lower than the lowest Nyquist frequency f_a that cause false colors. It is therefore ideal to entirely cut off the frequency components not lower than the lowest Nyquist frequency f_a . However, this is difficult with the actual optical low-pass filter 2. In this embodiment, the frequency characteristics of the optical low-pass filter 2 are set from the viewpoint of the ratio at which the frequency components lower than the image sensor Nyquist frequency $f_s/2$, which have been allowed to pass through in conventional imaging devices, are cut off. Two cases are assumed here: the case where the frequency components not lower than the lowest Nyquist frequency f_a is suppressed mainly by the optical low-pass filter 2; and the case where suppression by the image processing of the CPU 8 is utilized as much as possible and frequency components that cannot

be suppressed by the image processing are suppressed by the optical low-pass filter 2. An appropriate value for the frequency characteristics is set for each case.

First, in the case where false colors are reduced mainly by the optical low-pass filter 2, the optical low-pass filter 2 has the frequency characteristics as shown in Figure 9. Specifically, frequency components not lower than the lowest Nyquist frequency f_a and lower than the image sensor Nyquist frequency $f_s/2$ correspond to a first false color occurrence region. Then, a first false color passing ratio is defined as the ratio of frequency components allowed to pass through in the first false color occurrence region. The frequency components allowed to pass through in the first false color occurrence region shown in Figure 9 correspond to a first false color passing region. The first false color passing ratio is calculated by the ratio of the area of the first false color passing region to the area of the first false color occurrence region.

This embodiment sets the first false color passing ratio to 0.4 or below. This first false color passing ratio was calculated by assuming the crystal birefringence, which is generally utilized to implement the optical low-pass filter 2. That is, if a low-pass filter in which a light is passed through the crystal and separated into two lights

is provided, where the distance between the two imaging lights obtained by the separation is the pixel pitch d of the image sensor, then the optical low-pass filter 2 has a frequency characteristic that the null point frequency is $1/(2d)$ as shown in Figure 10.

However, in conventional single-chip digital cameras, since setting the null point frequency to $1/(2d)$ makes the resolution too low, the value of the null point frequency is set higher for reducing the effect of the low-pass filter. On the other hand, in this embodiment according to the present invention, the resolution of the output image signals can be relatively increased by the output image signal generating unit 6 even if the resolution is low at the sampling stage in the image sensor 5. Therefore, contrary to the conventional single-chip digital cameras, false colors can be suppressed without reducing the resolution although the effect of the low-pass filter is increased.

Thus, the position causing the optical low-pass filter 2 to separate the light by the pixel pitch d is the border between the conventional imaging devices and the imaging device of this embodiment. In both cases where the image sensor has the color filters arranged in the Bayer pattern on the imaging pixels arranged as a squared grid and where the image sensor has the color filters arranged in the

Bayer pattern on the imaging pixels arranged as a 45° oblique squared grid, $f_s/2 = 1/(2d)$, and $f_a = 1/(4d)$. Therefore, calculating the first false color passing ratio results in: the first false color passing ratio = $0.372892484 \approx 0.4$.

Thus, the first false color passing ratio in this embodiment is set to a value of 0.4 or below. In this case, while the optical low-pass filter 2 is set more intensively, the burden on the CPU 8 performing the image processing is advantageously reduced. Since false colors are caused not only by the aliasing of high frequency components due to the sampling in the image sensor 5, a certain degree of image processing is necessary in any situations.

In the case where false colors are reduced by making active use of the image processing of the CPU 8 with less intensive filtering by the optical low-pass filter 2, the optical low-pass filter 2 has the frequency characteristics as shown in Figure 11. Specifically, frequency components not lower than the intermediate frequency $(f_a + f_s/2)/2$ between the lowest Nyquist frequency f_a and the image sensor Nyquist frequency $f_s/2$, and lower than the image sensor Nyquist frequency $f_s/2$, correspond to a second false color occurrence region. Then, a second false color passing ratio is defined as the ratio of frequency components allowed to pass through in the second frequency component

occurrence region. This is based on the fact that frequency components closer to the lowest Nyquist frequency f_a are easier to suppress by the image processing while frequency components closer to the image sensor Nyquist frequency $f_s/2$ are harder to suppress by the image processing. The frequency components allowed to pass through in the second false color occurrence region shown in Figure 11 correspond to a second false color passing region. The second false color passing ratio is calculated by the ratio of the area of the second false color passing region to the area of the second false color occurrence region.

This embodiment sets the second false color passing ratio to 0.2 or below. This value was determined for the reason similar to the above-described first false color passing ratio, and calculated as: the second false color passing ratio = $0.194113388 \approx 0.2$. Therefore, while the image processing of the CPU 8 should be strictly performed, the optical low-pass filter 2 can advantageously be set less intensively.

Now, the lowest Nyquist frequency f_a will be described. Figure 12 shows the image sensor 5 arranged as a squared grid. In this case, if the pixel pitch d of the image sensor 5 is used as shown in Figure 12 (a), the sampling interval in the lateral direction for G is d (Figure 12 (b)), the sampling interval in the lateral direction for R (and B)

is $2d$ (Figure 12 (c)), the sampling interval in the oblique direction for G is $(\sqrt{2}) \times d$ (Figure 12 (d)), and the sampling interval in the oblique direction for R (and B) is $(\sqrt{2}) \times d$ (Figure 12 (e)). Among these sampling intervals, the longest sampling interval is the sampling interval $2d$ in the longitudinal and lateral directions for R and B. Therefore, the lowest Nyquist frequency f_a is $1/(4d)$, i.e., the Nyquist frequency in the longitudinal and lateral directions for R and B.

Figure 13 shows the image sensor 5 arranged as a 45° oblique squared grid. In this case, if the pixel pitch in the 45° oblique direction of the image sensor 5 is used as the pixel pitch d as shown in Figure 13 (a), the sampling interval in the lateral direction for G is $(\sqrt{2}) \times d$ (Figure 13 (b)), the sampling interval in the lateral direction for R (and B) is $(\sqrt{2}) \times d$ (Figure 13 (c)), the sampling interval in the oblique direction for G is d (Figure 13 (d)), and the sampling interval in the oblique direction for R (and B) is $2d$ (Figure 13 (e)). Among these sampling intervals, the longest sampling interval is the sampling interval $2d$ in the oblique direction for R and B. Therefore, the lowest Nyquist frequency f_a is $1/(4d)$, i.e., the Nyquist frequency in the oblique direction for R and B. This is the same as in the image sensor 5 arranged as a squared grid.

Thus, in this embodiment, when the image sensor 5 arranged as a squared grid or a 45° oblique squared grid (pixel pitch: d) is used to generate the output image, the optical filter 2 is selected such that the first false color occurrence region corresponds to values equal to or above $1/(4d)$ and below $1/(2d)$ and the condition of the above-described first or second color passing ratio is satisfied.

Now, an imaging method with the imaging device 1 in this embodiment will be described.

When an object is taken with the imaging device 1 in this embodiment, the imaging light from the object is first allowed to enter the optical low-pass filter 2 through the imaging optical system 3. For the imaging light that has entered the optical low-pass filter 2, spatial frequencies in a frequency region above the lowest Nyquist frequency f_a of the image sensor 5 are mainly cut off according to the predetermined frequency characteristics. The imaging light passed thorough the optical low-pass filter 2 is separated into R, G, and B color components by the color filters 4 and imaged on the photoreceptive surface of the image sensor 5. Here, since false colors are considerably removed by the optical low-pass filter 2 compared to conventional single-chip imaging devices,

the color reproduction ability for the output image is significantly improved.

The image sensor 5 accumulates, as electric charges, the imaging light that has entered the photodiodes constituting the pixels, and supplies the electric charges as pixel signals to the output image signal generating unit 6. Since the imaging light has been separated into three primary colors of R, G, and B by the color filters 4, the pixel signal for each pixel is read out as luminance information on one of the colors. The read-out pixel signals are converted into digital data by the A/D converter 7 and passed to the CPU 8. Based on the received pixel signals, the CPU 8 generates output image signals constituting the pixels of the output image. Here, since the number of pixels in the image sensor 5 used for generating each pixel of the output image is set larger compared to the conventional single-chip imaging devices, the resolution of the output image is significantly improved.

The output image signals obtained in the above manner are supplied as output signals of a digital camera or digital video camera provided with the imaging device 1 in this embodiment.

Now, specific examples of this embodiment will be described. In the following examples 1 to 5, the conversion ratio in the resolution conversion processing of the CPU

8, i.e., the number N of pixel signals used for generating an output image signal for one pixel, was determined for different pixel arrangements of the image sensor 5 and different ratios k ($D = kd$) of the pixel pitch D ($= 1/F_s$) of the output image to the pixel pitch d ($= 1/f_s$) of the image sensor 5. In the following examples 1 to 5, as described above, the optical low-pass filter 2 with the frequency characteristics satisfying the condition of the first or second false color passing ratio was used. The color filters 4 used were arranged in the Bayer pattern.

<Example 1>

In the example 1, as shown in Figure 14, the image sensor 5 was used in which pixels were arranged as a squared grid and the ratio k of the pixel pitch D of the output image to the pixel pitch d of the image sensor 5 was 1.5 ($D = 1.5d$). As can be seen from Figure 14, since 2.25 pixel signals were sampled for an output image signal for one pixel, N is 2.25.

<Example 2>

In the example 2, as shown in Figure 15, the image sensor 5 was used in which pixels were arranged as a squared grid and the ratio k of the pixel pitch D of the output image to the pixel pitch d of the image sensor 5 was 2 ($D = 2d$). As can be seen from Figure 15, since 4 pixel

signals were sampled for an output image signal for one pixel, N is 4.

<Example 3>

In the example 3, as shown in Figure 16, the image sensor 5 was used in which pixels were arranged as a squared grid and the ratio k of the pixel pitch D of the output image to the pixel pitch d of the image sensor 5 was 4 ($D = 4d$). As can be seen from Figure 16, since 16 pixel signals were sampled for an output image signal for one pixel, N is 16.

<Example 4>

In the example 4, as shown in Figure 17, the image sensor 5 was used in which pixels were arranged as a 45° oblique squared grid and the ratio k of the pixel pitch D of the output image to the pixel pitch d of the image sensor 5 was $\sqrt{2}$ ($D = (\sqrt{2}) \times d$). As can be seen from Figure 17, since 2 pixel signals were sampled for an output image signal for one pixel, N is 2.

<Example 5>

In the example 5, as shown in Figure 18, the image sensor 5 was used in which pixels were arranged as a 45° oblique squared grid and the ratio k of the pixel pitch D of the output image to the pixel pitch d of the image sensor 5 was $2\sqrt{2}$ ($D = (2\sqrt{2}) \times d$). As can be seen from Figure

18, since 8 pixel signals were sampled for an output image signal for one pixel, N is 8.

It can be seen from the above examples 1 to 5 that, irrespective of the manner of arrangement of the image sensor 5, the number N of pixel signals generated by the image sensor 5 correspond to one output image signal is expressed as:

$$N = k^2 = (D/d)^2 = (f_s/F_s)^2 \dots \text{Formula (1)}.$$

The sampling frequency F_s of the output image is expressed as:

$$F_s = 1/D = 1/(kd) = f_s/k \dots \text{Formula (2)}.$$

Therefore, in the examples 1 to 5, the relationship between the frequency of the pixel signals generated by the image sensor 5 and the maximum frequency $F_s/2$ that can be represented in the output image is as shown in Figure 19. Further, since the frequency F of the output image is proportional to the frequency f of the pixel signals generated by the image sensor 5, $F = f/k$. Thus, if k is set to a value above 1.0, the frequency f of the image sensor 5 required to represent the frequency F of the output image can be low. This allows the resolution of the output image to be relatively improved.

According to the above embodiment, compared to conventional products, a larger number of pixels of the image sensor 5 are set per pixel of the output image, and

also the optical low-pass filter 2 significantly removes false color components. This provides a conventionally unachieved superior effect that the color reproduction ability and the resolution ability can be improved to the level of a three-chip image sensor while the simple single-chip image sensor 5 is used.

The imaging device 1 according to the present invention is not limited to the above-described embodiment but may be modified as appropriate.

For example, although the embodiment has been described for the output image based on square pixels, this is not a limitation but an output image based on rectangular pixels may be configured and output. In that case, the sampling frequency will be different in the longitudinal direction and the lateral direction. The illustrated image sensor 5 has the imaging pixels arranged as a squared grid or a 45° oblique squared grid, and the illustrated color filters 4 are arranged in the Bayer pattern. However, this is not a limitation but the present invention is also applicable when other arrangements are selected.

Industrial Applicability

The present invention is useful for an imaging device that takes an image of an object with a single-chip image sensor.

CLAIMS

1. An imaging device, comprising:

an imaging optical system with an optical low-pass filter having predetermined frequency characteristics;

color filters in a Bayer arrangement that separate an imaging light passed through the imaging optical system into predetermined color components;

a single-chip image sensor that photoelectrically converts the imaging light passed through the color filters to generate pixel signals; and

an output image signal generating unit that generates output image signals based on the pixel signals obtained from the image sensor, wherein

the frequency characteristics of the optical low-pass filter are set in such a way that a first false color passing ratio is 0.372892484 or less but more than 0, the first false color passing ratio indicating the ratio of frequency components allowed to pass through in a frequency component region not lower than the Nyquist frequency for the lowest sampling frequency among sampling frequencies in the longitudinal, lateral, and oblique directions for each color component in the image sensor, and lower than the Nyquist frequency for the sampling frequency of the image sensor, and

the output image signals are generated from the pixel signals generated by the image sensor so that N pixel signals (N is a real number of 2 or above) generated by the image sensor correspond to one output image signal.

2. The imaging device according to claim 1,

$$N = (f_s/F_s)^2,$$

wherein f_s is the sampling frequency of the image sensor and F_s is the sampling frequency of an output image formed by the output image signals.

3. An imaging device, comprising:

an imaging optical system with an optical low-pass filter having predetermined frequency characteristics;

color filters in a Bayer arrangement that separate an imaging light passed through the imaging optical system into predetermined color components;

a single-chip image sensor that photoelectrically converts the imaging light passed through the color filters to generate pixel signals; and

an output image signal generating unit that generates output image signals based on the pixel signals obtained from the image sensor, wherein

the frequency characteristics of the optical low-pass filter are set in such a way that a second false color

passing ratio is 0.194113388 or less but more than 0, the second false color passing ratio indicating the ratio of frequency components allowed to pass through in a frequency component region not lower than the intermediate frequency between the Nyquist frequency for the lowest sampling frequency among sampling frequencies in the longitudinal, lateral, and oblique directions for each color component in the image sensor and the Nyquist frequency for the sampling frequency of the image sensor, and lower than the Nyquist frequency for the sampling frequency of the image sensor, and

the output image signals are generated from the pixel signals generated by the image sensor so that N pixel signals (N is a real number of 2 or above) generated by the image sensor correspond to one output image signal.

4. The imaging device according to claim 3,

$$N = (f_s/F_s)^2,$$

wherein f_s is the sampling frequency of the image sensor and F_s is the sampling frequency of an output image formed by the output image signals.